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FEE TRANSMITTAL for FY 2003

Effective 01/01/2003. Patent fees are subject to annual revision.

 Applicant claims small entity status. See 37 CFR 1.27

TOTAL AMOUNT OF PAYMENT (\$ 750.00)

Complete if Known

Application Number	06/687,048
Filing Date	10/13/2000
First Named Inventor	Tae Heon Lee et al.
Examiner Name	Dilinh P. Nguyen
Art Unit	2814
Attorney Docket No.	AMKOR-052RCE

METHOD OF PAYMENT (check all that apply)

Check Credit card Money Order Other None

Deposit Account:

Deposit Account Number 19-4330
Deposit Account Name Stetina Brunda Garred & Brucker

The Commissioner is authorized to: (check all that apply)

- Charge fee(s) indicated below Credit any overpayments
 Charge any additional fee(s) during the pendency of this application
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FEE CALCULATION (continued)

3. ADDITIONAL FEES

Large Entity	Small Entity	Fee Description	Fee Paid
Fee Code (\$)	Fee Code (\$)	Fee Description	Fee Paid
1001 750	2001 375	Utility filing fee	
1002 330	2002 165	Design filing fee	
1003 520	2003 260	Plant filing fee	
1004 750	2004 375	Reissue filing fee	
1005 160	2005 80	Provisional filing fee	
SUBTOTAL (1) (\$)			
2. EXTRA CLAIM FEES FOR UTILITY AND REISSUE			
Total Claims	Extra Claims	Fee from below	Fee Paid
Independent Claims			
Multiple Dependent			
Fee Code (\$)	Fee Code (\$)	Fee Description	Fee Paid
1202 18	2202 9	Claims in excess of 20	
1201 84	2201 42	Independent claims in excess of 3	
1203 280	2203 140	Multiple dependent claim, if not paid	
1204 84	2204 42	** Reissue independent claims over original patent	
1205 18	2205 9	** Reissue claims in excess of 20 and over original patent	
SUBTOTAL (2) (\$)			
Other fee (specify) _____			
*Reduced by Basic Filing Fee Paid		SUBTOTAL (3) (\$)	750.00

*or number previously paid, if greater; For Reissues, see above

SUBMITTED BY	(Complete if applicable)		
Name (Print/Type)	Mark B. Garred	Registration No. (Attorney/Agent)	34,823
Signature		Telephone	(949) 855-1246

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ATTORNEY DOCKET NO: AMKOR-052RCE
TITLE: LEADFRAME AND SEMICONDUCTOR PACKAGE WITH IMPROVED
SOLDER JOINT STRENGTH

Certificate of Mailing under 37 CFR 1.8 or 37 CFR 1.10

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